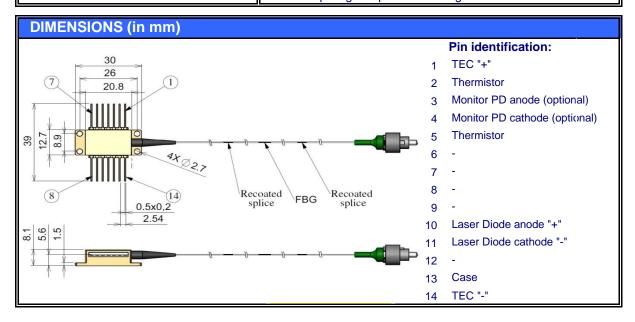
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FBG-10XX-FBG-400_500									
Fiber Bragg Grating wavelength locked High Power Laser Diode									
Features:									
• FBG wavelength stabilized									
• 400 / 500mW output power ex-single mode fiber									
• Available wavelength range 1010-1130pm									
Proprietary mirror coating technology enabling high reliability									
			ning PM98						
			and therma	i cycling sc	reening				
I WALKA		al monitor photodiode compliance							
AVAILABLE POWER OP					e estador ta				
Test conditions: CW operation	, chip temperature 25°C, the	e case is moui				word			
Port Number	Output power (mW) Pout		Operating current		Forward				
Part Number			(mA)		voltage (V)				
LD-10XX-FBG-400	400		Typ.	Max.	Typ.	Max.			
	-		800 1050	1000 1250	1.7 1.8	1.9			
	LD-10XX-FBG-500 500			1230	1.0	2.0			
SPECIFICATIONS									
	, recomended chip tempera								
Parameters		Symb.	Min.	Тур.	Max.	Unit			
Kink-free* output power			1.1×Pout	1.3×Pout		mW			
Range of available wavelength		λ	1010		1130	nm			
Mean wavelength tolerance					2	nm			
Spectral width @ -3dB level at Pou	Δλ			0.100	nm				
Threshold current	lth		80	100	mA "O				
Wavelength shift with FBG tempera	Δλ/ΔT fbg	00	9	12	pm/°C				
Distance from chip to FBG Recommended chip temperature	D	80 20	100 25	120 40	cm °C				
Polarization Extinction Ratio **	Top PER	12	20	40	dB				
Polarization Extinction Ratio ***	PER	12			dB				
[*] ΔΡ/ΔΙ > 0 (ΔI=5mA) ** 1010-1050nm range **** 1050-1130nm range									
TYPICAL PERFORMANC	E for r <u>eference o</u>	nly*							
	, chip temperature 25°C, the		nted on room	temperature h	eatsink				
Light-Current-Voltage C				al Charact					
800 т	_ _2	3	30			00 mA			
700 Power Voltage	1.8		20						
	1.6	2							
600 €	1.4	Ē	10			_			
Mm 500 100 100 100 100 100 100 100	1.2 g	ntensity, dBm/0.06nm	0						
400	1.2 (b) 1.2 (c) 1.2 (c	шар Шар							
H 300	48.0 A	j. j. Sit	0						
500	0.6	- uten	20						
200	0.4	-		1/		-			
100	0.2	-3	30						
0 500 1000 1500 1070 1072 1074 1076 1078 1080 Forward Current, mA Wavelength, nm									
* Performance is given for the 1075nm device. Similar performance is expected for the other wavelengths in the 1010-1130nm range.									

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ABSOLUTE MAXIMUM RATINGS							
Parameters	Min.	Max.	Unit				
Laser Diode reverse voltage	-	2	V				
Laser Diode CW forward current	-	lop+300	mA				
Thermo Electric Cooler current	-	3	А				
Thermo Electric Cooler voltage	-	4	V				
Fiber bend radius	3	-	cm				
Chip operating temperature range	5	40	°C				
Case operating temperature range	0	70	°C				
FBG operating temperature range	-40	120	°C				
Storage temperature range	-40	85	°C				

THERMISTOR SPECIFICATION		FIBER SPECIFICATION				
Parameters	Value	Unit	Parameters		PM980	Unit
Thermistor type	NTC	-	Numerical aperture (Typical)		0.12	
Resistance @25°C	10 ± 0.1	kOhm	Cutoff wavelength		900±70	nm
Beta 0-50°C	3375±1%	K	Mode-field diameter (@1060nm)		6.6±0.3	μm
· · ·		Cladding diameter		125±1	μm	
		Coating diameter		245±15	μm	
R-T CURVE		Length		1.6±0.2	m	
30000			Connector	FC/APC (narrow key)		
	00 35 40 45 5 Sperature, C	0 55 60	Connector alignment to the PANDA fiber			
			The output light is polarized along the slow axis of PM fiber.			



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SAFETY AND OPERATING INSTRUCTIONS

The light emitted from this device is invisible and can be harmful to the human eye. Avoid looking directly into the fiber connector when the device is in operation. Proper laser safety eyewear must be worn during operation with open connector.

Absolute Maximum Ratings may be applied to the device for short period of time only. Exposure to maximum ratings for extended period of time or exposure to more than one maximum rating may cause damage or affect the reliability of the device. Operating the device outside of its maximum ratings may cause device failure or a safety hazard. Power supplies used with the component must be employed such that the maximum forward current cannot be exceeded.

A proper heatsink for the device on thermal radiator is required. The device must be mounted on radiator with 4 screws (bolt down in X-style fashion with initial torque set to 0.075Nm and final X-style bolt down at 0.15Nm) or with clamps. The deviation from flatness of radiator surface must be less than 0.05mm. It's recommended using of Indium foil or thermal conductive and soft material between bottom of the case and heatsink for thermal interface. It's undesirable to use thermal grease for this.

Avoid back reflection to the device. It may give impact on the device performance in aspects of spectrum and power stability. It also may cause fatal facet damage. Using of optical isolators is highly recommended to block back reflection.

Do not pull the fiber. Do not bend a fiber with a radius smaller than 3 cm. Fiber tip should always be protected from any contamination or damage during the process of installation. After removing the dust-preventing cap covered at fiber tip, carefully clean fiber tip by wiping through one direction using optical lens cleaning paper or cotton swab dabbed with Iso-Propanol or Ethyl alcohol. Operate the device with clean fiber connector only.

Electrostatic discharge is the primary cause of unexpected product failure. Take extreme precaution to prevent ESD. During device installation, ESD protection has to be maintained - use wrist straps, grounded work surfaces and rigorous antistatic techniques when handling the product.









Example of Part Number Identification

FBG-1030-PM-500 -> 500mW output power at mean wavelength 1030nm FBG-1064-PM-400 -> 400mW output power at mean wavelength 1064nm

NOTE: Innolume product specifications are subject to change without notice